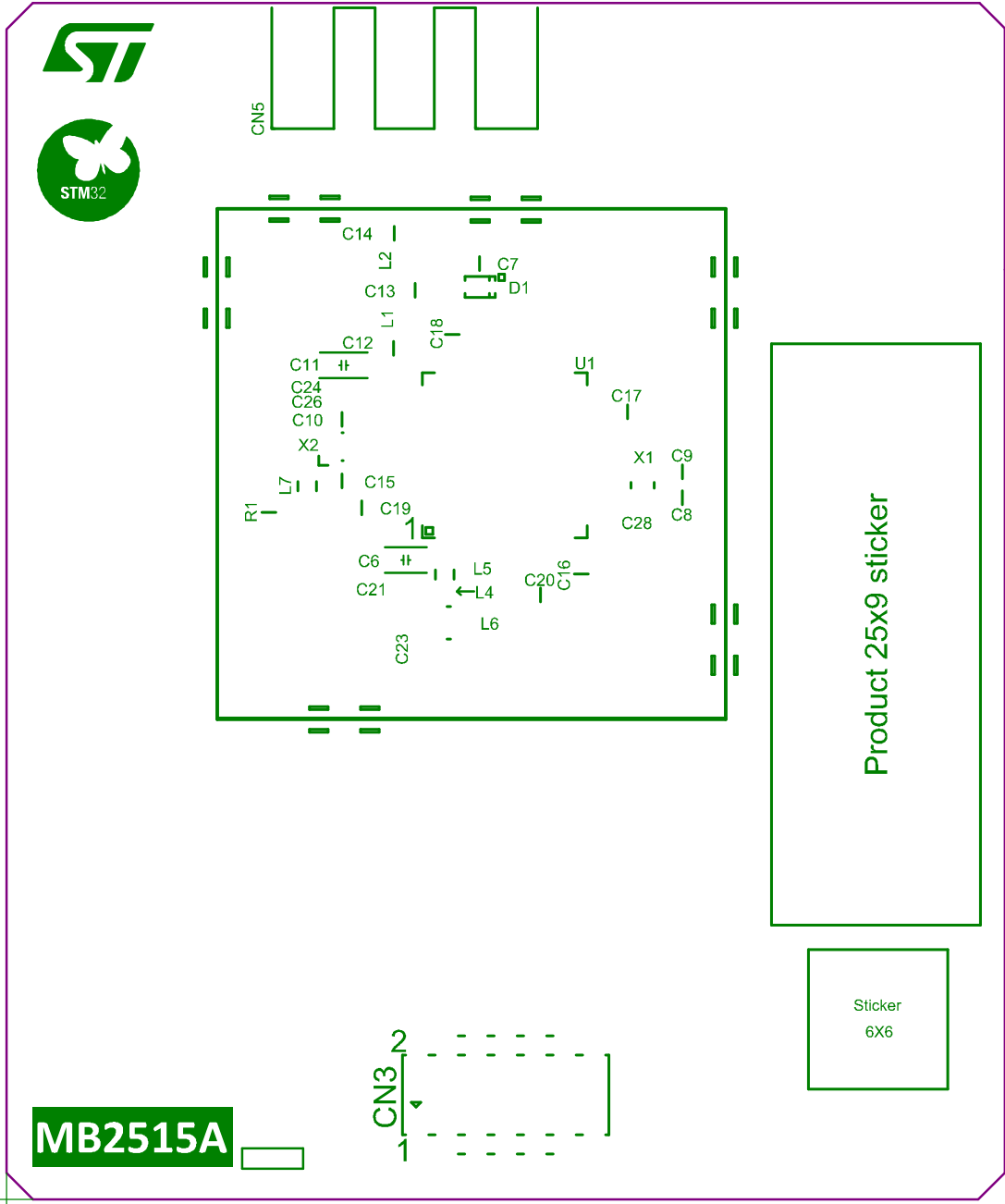
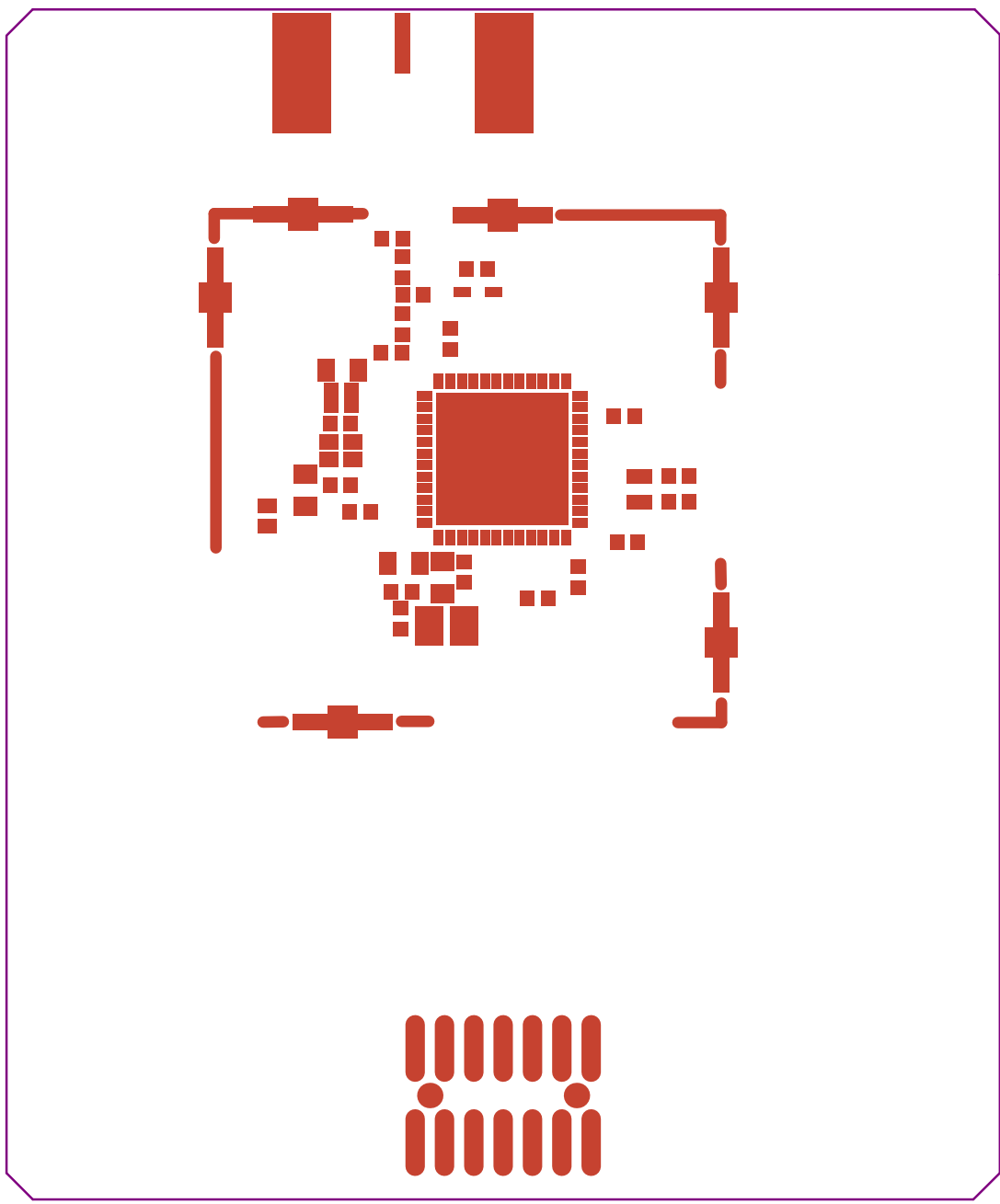
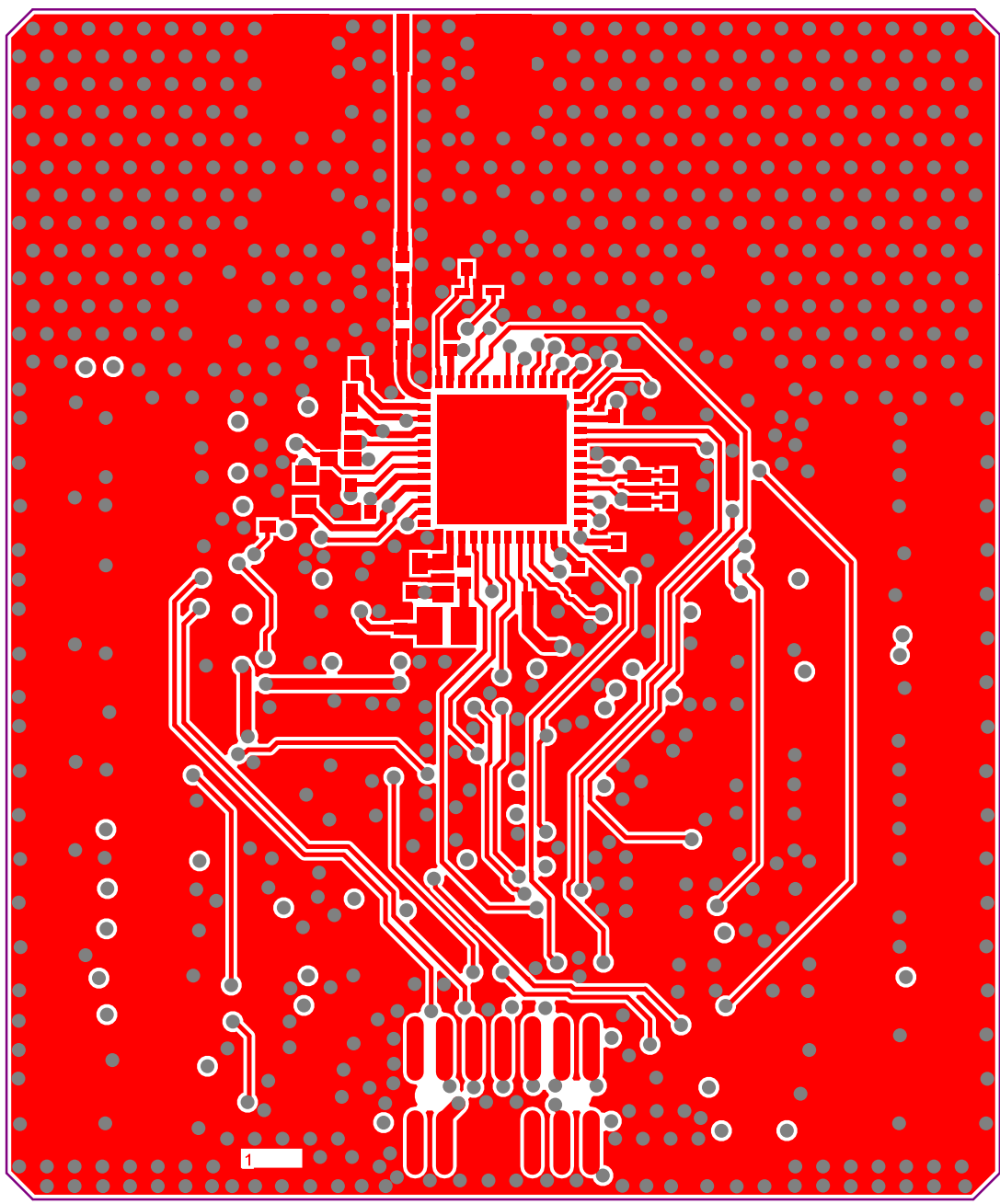
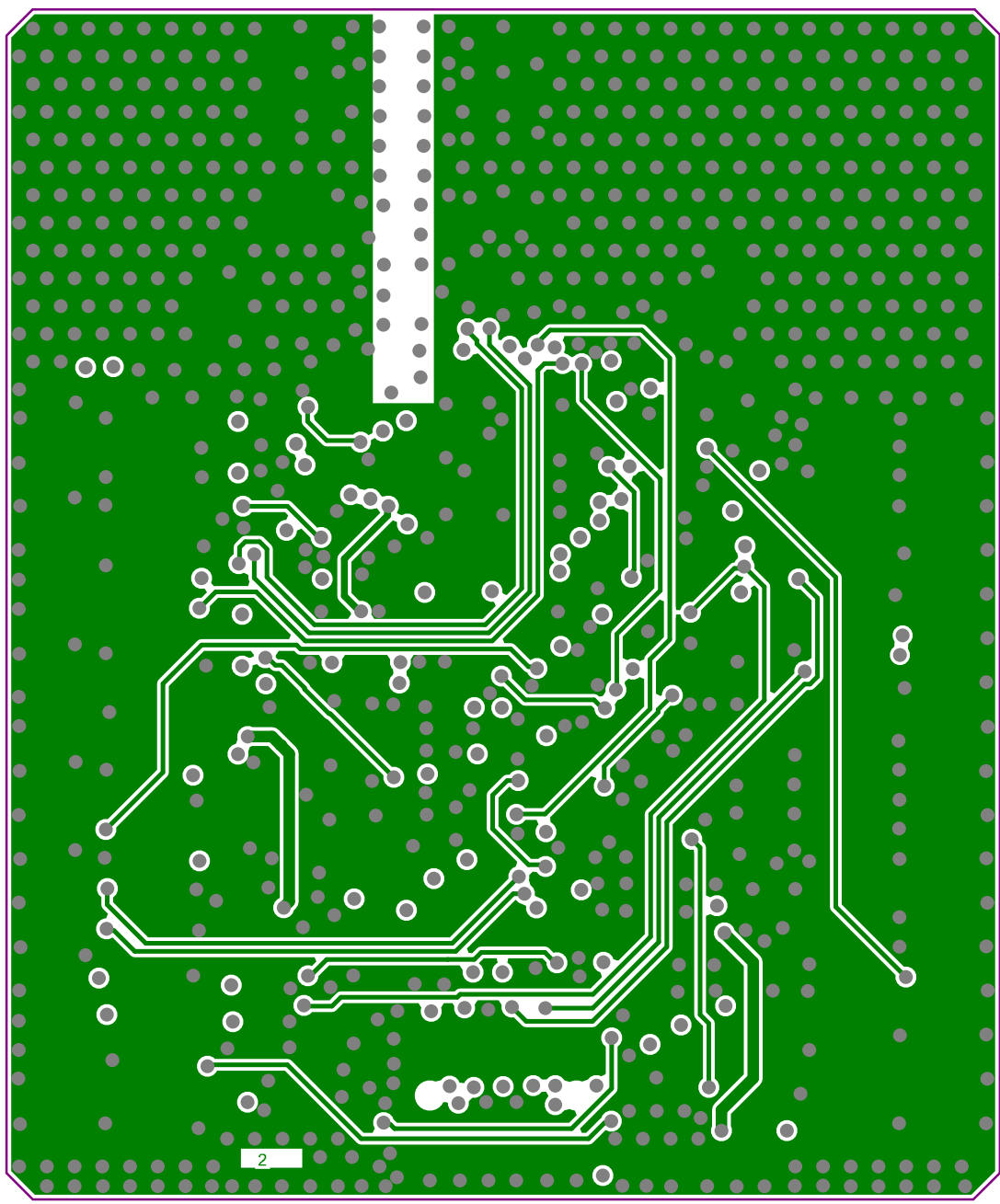
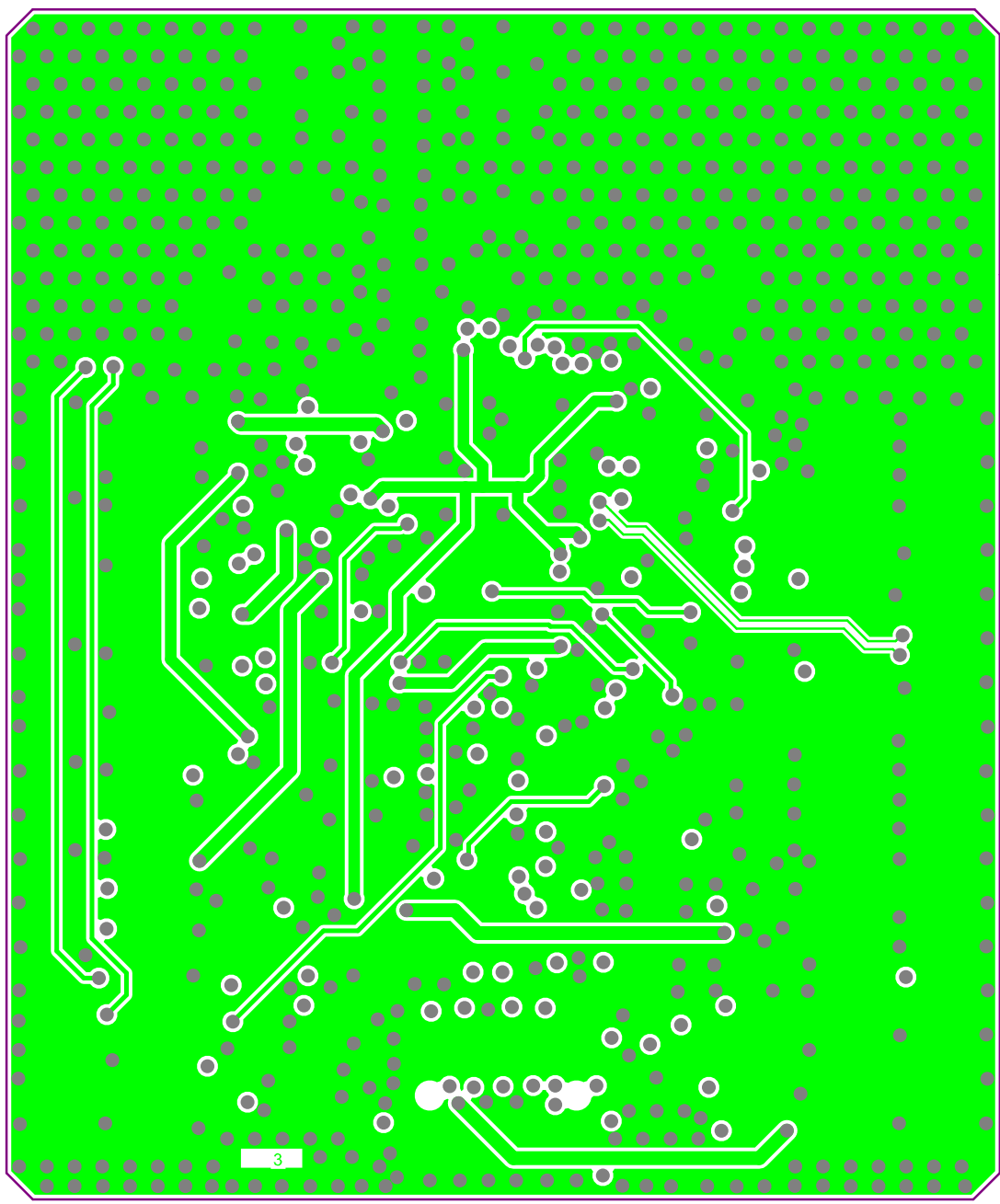


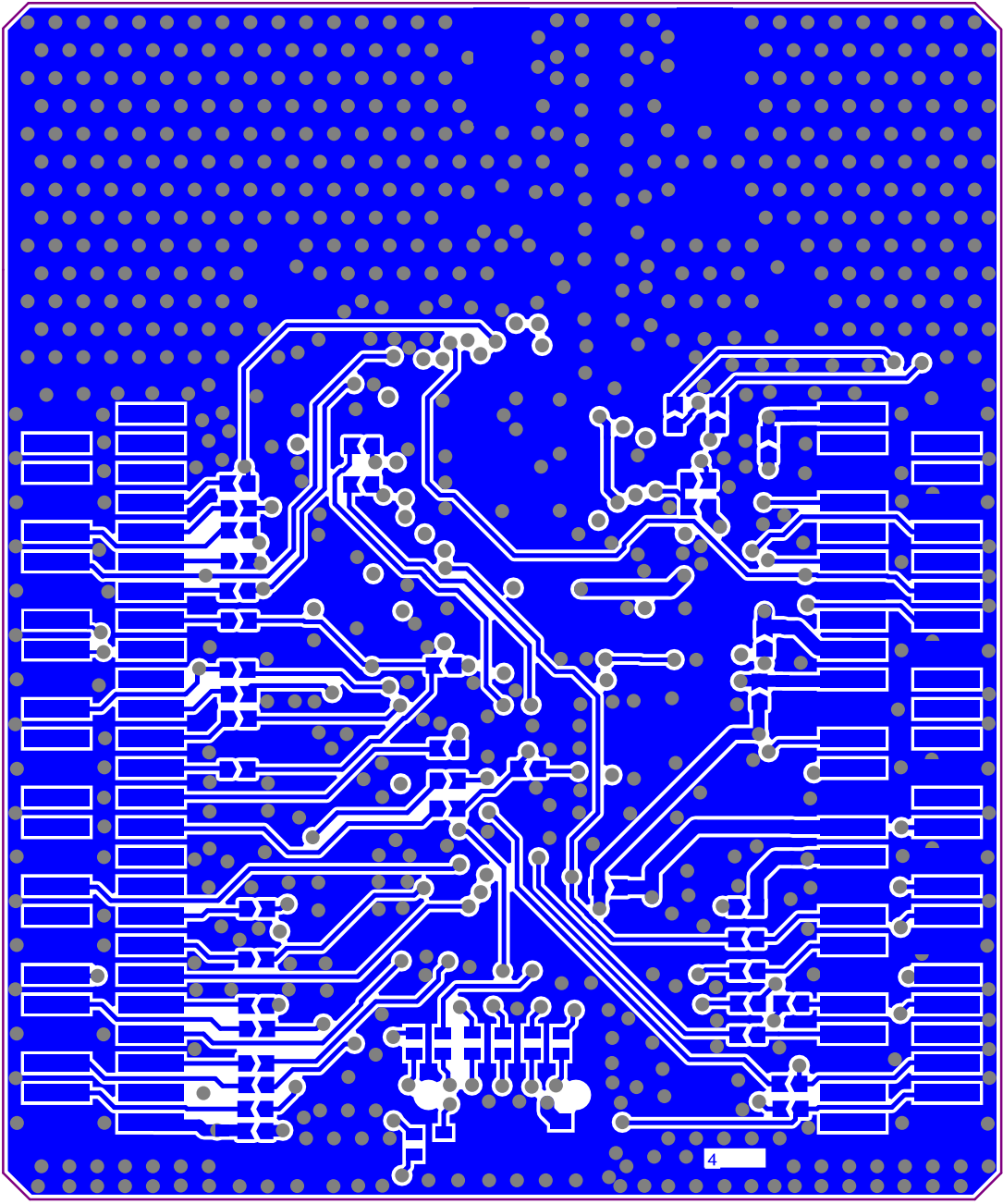


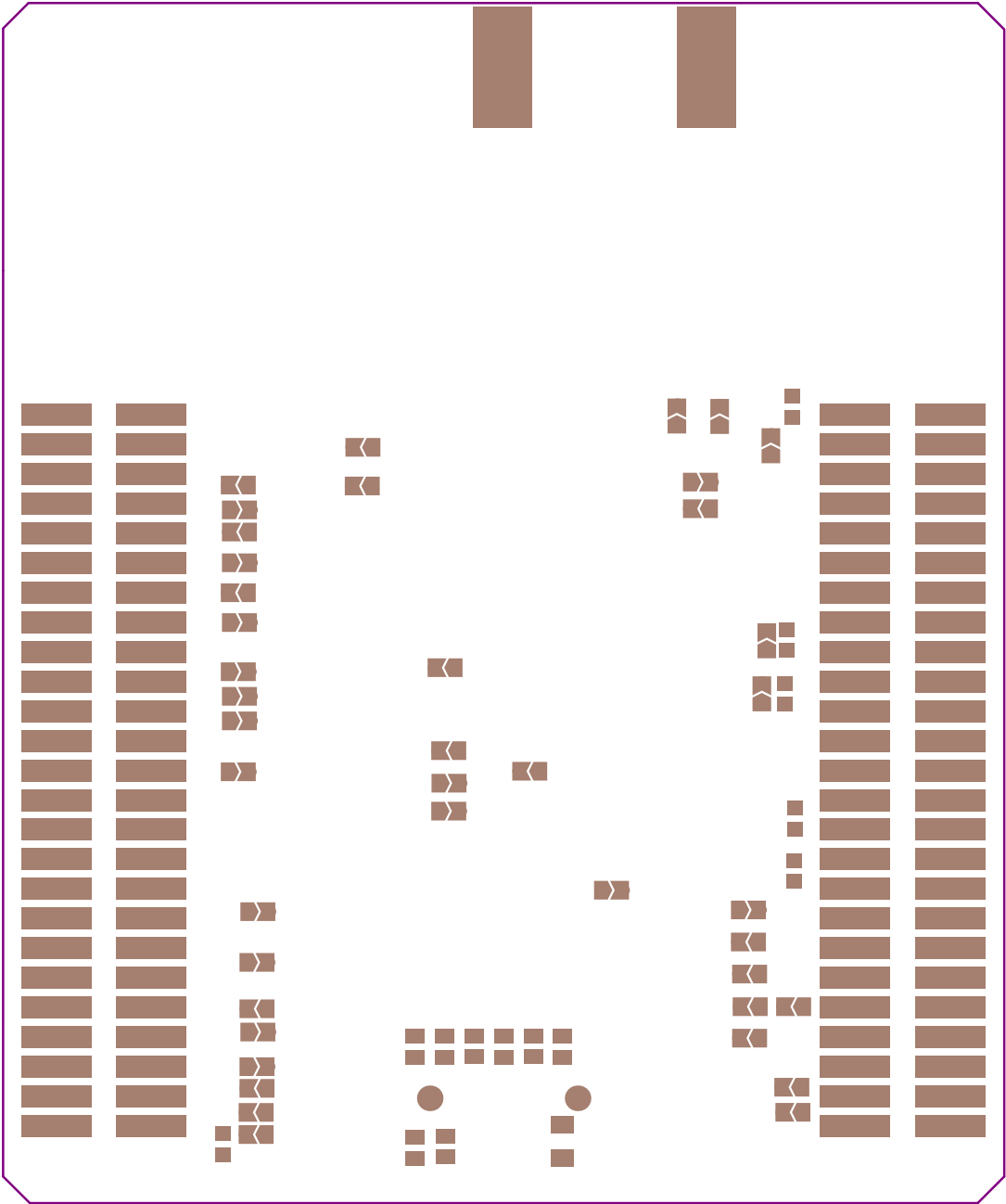






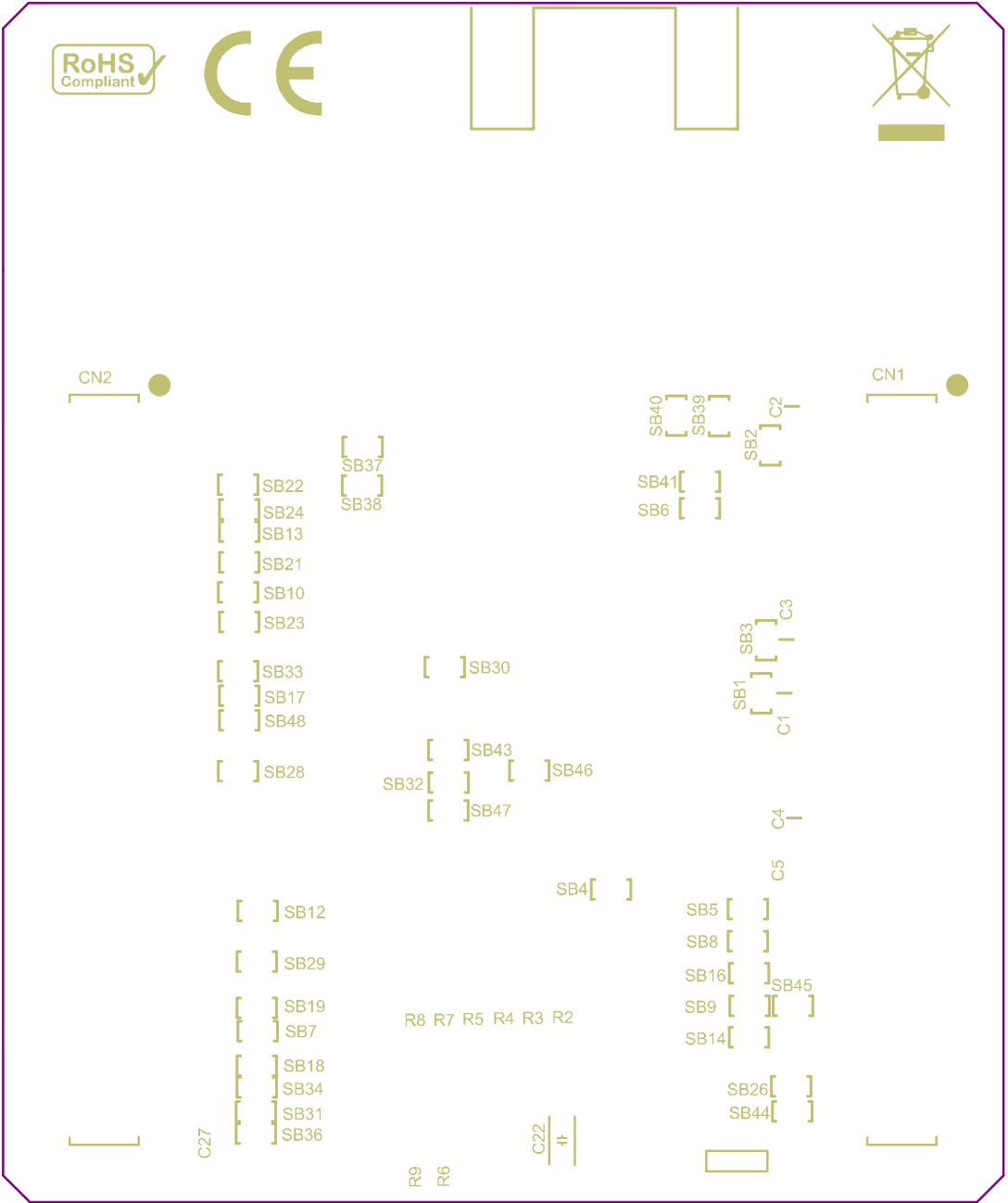






Layer	Name	Material	Thickness	Constant	Board Layer Stack
	Top Overlay				
	Top Solder	Solder Resist	0.018mm	4.2	
1	Top Layer		0.041mm		
	Dielectric 1	FR-4	0.076mm	3.7	
2	Internal 1		0.030mm		
	Dielectric 3	FR-4	1.270mm	4.6	
3	Internal 2		0.030mm		
	Dielectric 2	FR-4	0.076mm	3.7	
4	Bottom Layer		0.041mm		
	Bottom Solder	Solder Resist	0.018mm	4.2	
	Bottom Overlay				

Total board thickness: 1.600mm



Symbol	Count	Hole Size	Plated	Hole Type	Drill Layer Pair	Via/Pad	Pad Shape	Template	Description	Hole Tolerance (+)	Hole Tolerance (-)
⊕	2	1.000mm (39.37mil)	NPTH	Round	Top Layer - Bottom Layer	Pad	Rounded	c0hn100m105p0			
□	852	0.300mm (11.81mil)	PTH	Round	Top Layer - Bottom Layer	Via	Rounded	(Mixed)			
	854 Total										

